



# BAW56M

## High-speed switching diode

28 October 2022

Product data sheet

### 1. General description

High-speed switching diode, encapsulated in a ultra small SOT883 (SC-101) Surface-Mounted Device (SMD) plastic package.

### 2. Features and benefits

- High switching speed:  $t_{rr} \leq 4$  ns
- Low capacitance:  $C_d \leq 2$  pF
- Low leakage current
- Reverse voltage:  $V_R \leq 90$  V
- Ultra small SMD plastic packages
- AEC-Q101 qualified

### 3. Applications

- High-speed switching
- General-purpose switching

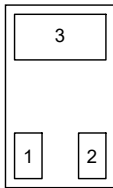
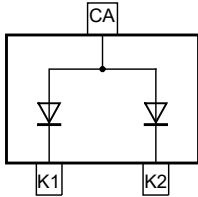
### 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Per diode</b>						
$I_R$	reverse current	$V_R = 80$ V; $T_{amb} = 25$ °C	-	-	0.5	$\mu$ A
$V_R$	reverse voltage		-	-	90	V
$t_{rr}$	reverse recovery time	$I_F = 10$ mA; $I_R = 10$ mA; $R_L = 100$ $\Omega$ ; $I_{R(meas)} = 1$ mA; $T_{amb} = 25$ °C	-	-	4	ns

### 5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K1	cathode (diode 1)	 <p>Transparent top view</p> <p><b>DFN1006-3 (SOT883)</b></p>	 <p>006aab099</p>
2	K2	cathode (diode 2)		
3	CA	common anode		

## 6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
<a href="#">BAW56M</a>	DFN1006-3	plastic, leadless ultra small package; 3 terminals; 0.35 mm pitch; 1 mm x 0.6 mm x 0.48 mm body	<a href="#">SOT883</a>

## 7. Marking

Table 4. Marking codes

Type number	Marking code
BAW56M	S5

## 8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
<b>Per diode</b>					
$V_{RRM}$	repetitive peak reverse voltage		-	90	V
$V_R$	reverse voltage		-	90	V
$I_F$	forward current	$T_{amb} \leq 25\text{ °C}$	-	150	mA
$I_{FSM}$	non-repetitive peak forward current	$t_p = 1\ \mu\text{s}$ ; square wave; $T_{j(\text{init})} = 25\text{ °C}$	-	4	A
		$t_p = 1\ \text{ms}$ ; square wave; $T_{j(\text{init})} = 25\text{ °C}$	-	1	A
		$t_p = 1\ \text{s}$ ; square wave; $T_{j(\text{init})} = 25\text{ °C}$	-	0.5	A
$I_{FRM}$	repetitive peak forward current		-	500	mA
$P_{tot}$	total power dissipation	$T_{amb} \leq 25\text{ °C}$	[1] [2]	250	mW
<b>Per device</b>					
$I_F$	forward current	$T_{amb} \leq 25\text{ °C}$	-	75	mA
$T_j$	junction temperature		-	150	°C
$T_{amb}$	ambient temperature		-65	150	°C
$T_{stg}$	storage temperature		-65	150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

## 9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
<b>Per diode</b>							
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1] [2]	-	-	500	K/W

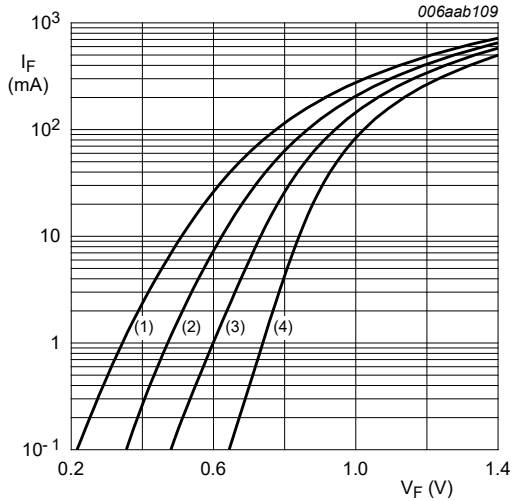
[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

## 10. Characteristics

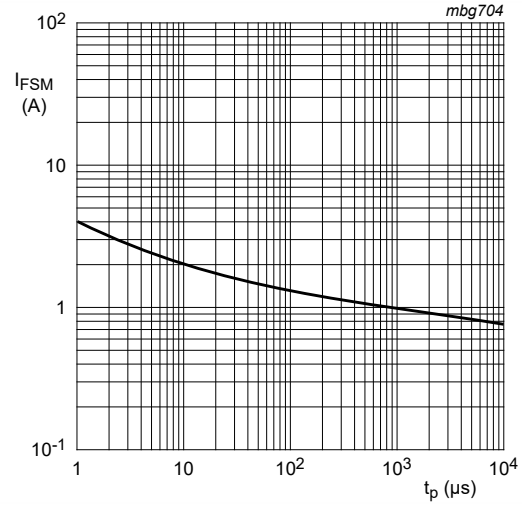
Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
<b>Per diode</b>							
$V_F$	forward voltage	$I_F = 1 \text{ mA}; t_p \leq 300 \mu\text{s}; \delta \leq 0.02;$ pulsed; $T_{amb} = 25 \text{ }^\circ\text{C}$		-	-	715	mV
		$I_F = 10 \text{ mA}; t_p \leq 300 \mu\text{s}; \delta \leq 0.02;$ pulsed; $T_{amb} = 25 \text{ }^\circ\text{C}$		-	-	855	mV
		$I_F = 50 \text{ mA}; t_p \leq 300 \mu\text{s}; \delta \leq 0.02;$ pulsed; $T_{amb} = 25 \text{ }^\circ\text{C}$		-	-	1	V
		$I_F = 150 \text{ mA}; t_p \leq 300 \mu\text{s}; \delta \leq 0.02;$ pulsed; $T_{amb} = 25 \text{ }^\circ\text{C}$		-	-	1.25	V
$I_R$	reverse current	$V_R = 25 \text{ V}; T_{amb} = 25 \text{ }^\circ\text{C}$		-	-	30	nA
		$V_R = 80 \text{ V}; T_{amb} = 25 \text{ }^\circ\text{C}$		-	-	0.5	$\mu\text{A}$
		$V_R = 25 \text{ V}; T_j = 150 \text{ }^\circ\text{C}$		-	-	30	$\mu\text{A}$
		$V_R = 80 \text{ V}; T_j = 150 \text{ }^\circ\text{C}$		-	-	150	$\mu\text{A}$
$C_d$	diode capacitance	$V_R = 0 \text{ V}; f = 1 \text{ MHz}; T_{amb} = 25 \text{ }^\circ\text{C}$		-	-	2	pF
$t_{rr}$	reverse recovery time	$I_F = 10 \text{ mA}; I_R = 10 \text{ mA}; R_L = 100 \Omega;$ $I_{R(meas)} = 1 \text{ mA}; T_{amb} = 25 \text{ }^\circ\text{C}$		-	-	4	ns
$V_{FRM}$	peak forward recovery voltage	$I_F = 10 \text{ mA}; t_r = 20 \text{ ns}; T_{amb} = 25 \text{ }^\circ\text{C}$		-	-	1.75	V



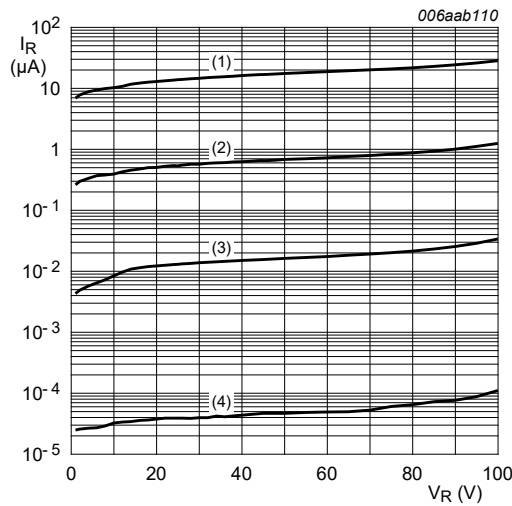
- (1)  $T_{amb} = 150\text{ °C}$
- (2)  $T_{amb} = 85\text{ °C}$
- (3)  $T_{amb} = 25\text{ °C}$
- (4)  $T_{amb} = -40\text{ °C}$

**Fig. 1. Forward current as a function of forward voltage; typical values**



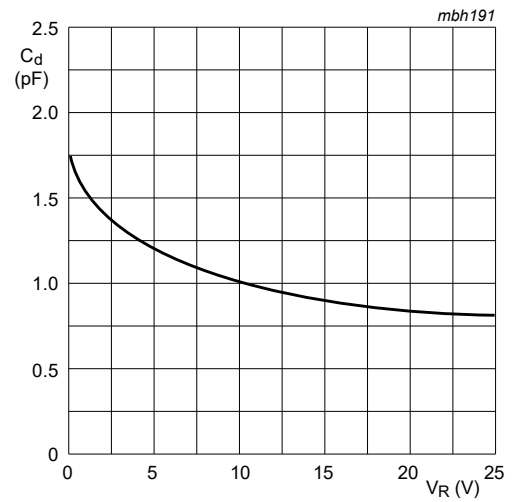
Based on square wave currents.  
 $T_{j(init)} = 25\text{ °C}$

**Fig. 2. Non-repetitive peak forward current as a function of pulse duration; typical values**



- (1)  $T_{amb} = 150\text{ °C}$
- (2)  $T_{amb} = 85\text{ °C}$
- (3)  $T_{amb} = 25\text{ °C}$
- (4)  $T_{amb} = -40\text{ °C}$

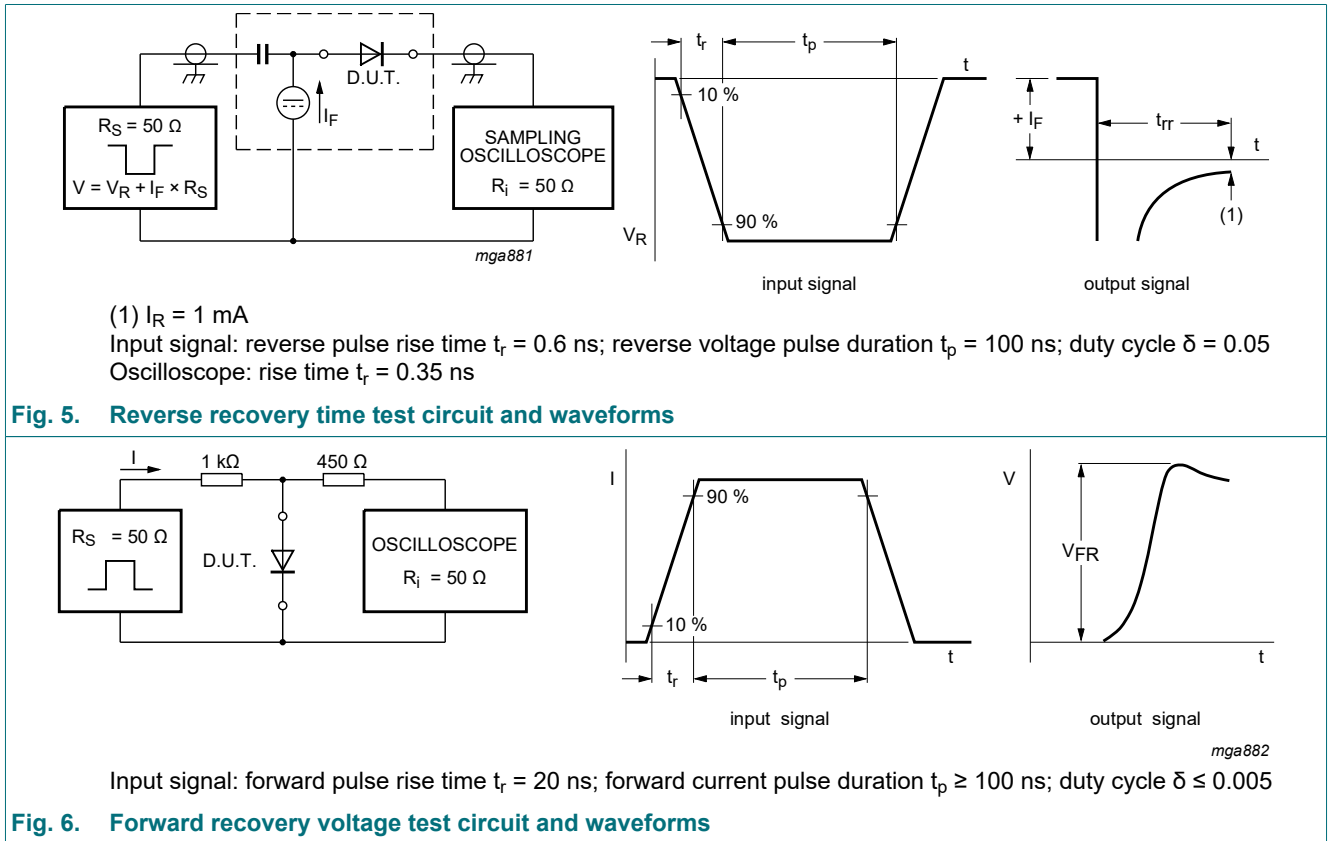
**Fig. 3. Reverse current as a function of reverse voltage; typical values**



$f = 1\text{ MHz}$   
 $T_{amb} = 25\text{ °C}$

**Fig. 4. Diode capacitance as a function of reverse voltage; typical values**

### 11. Test information



#### Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

## 12. Package outline

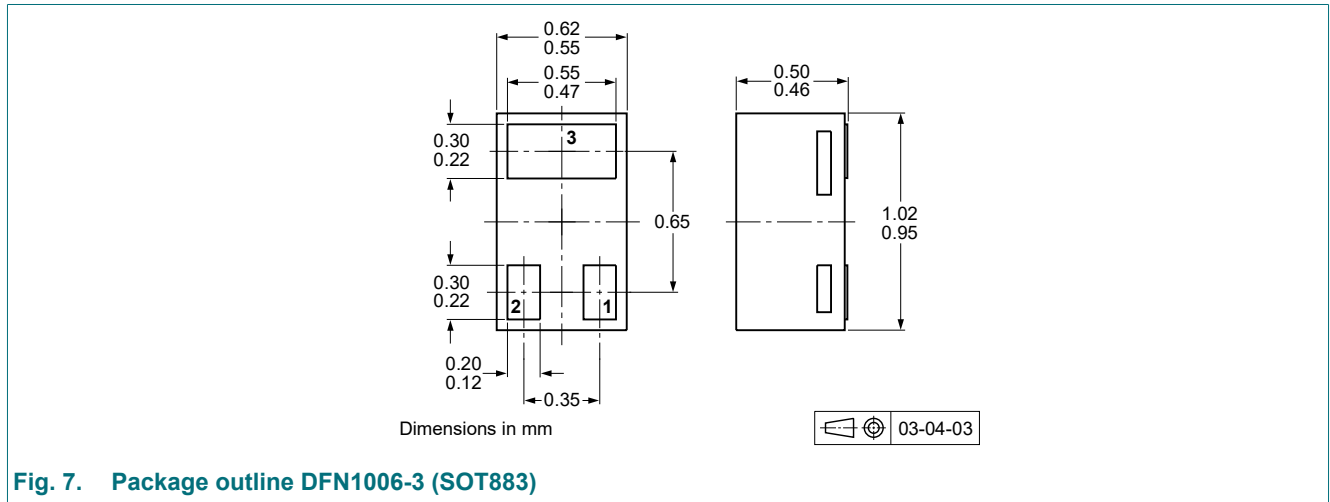


Fig. 7. Package outline DFN1006-3 (SOT883)

### 13. Soldering

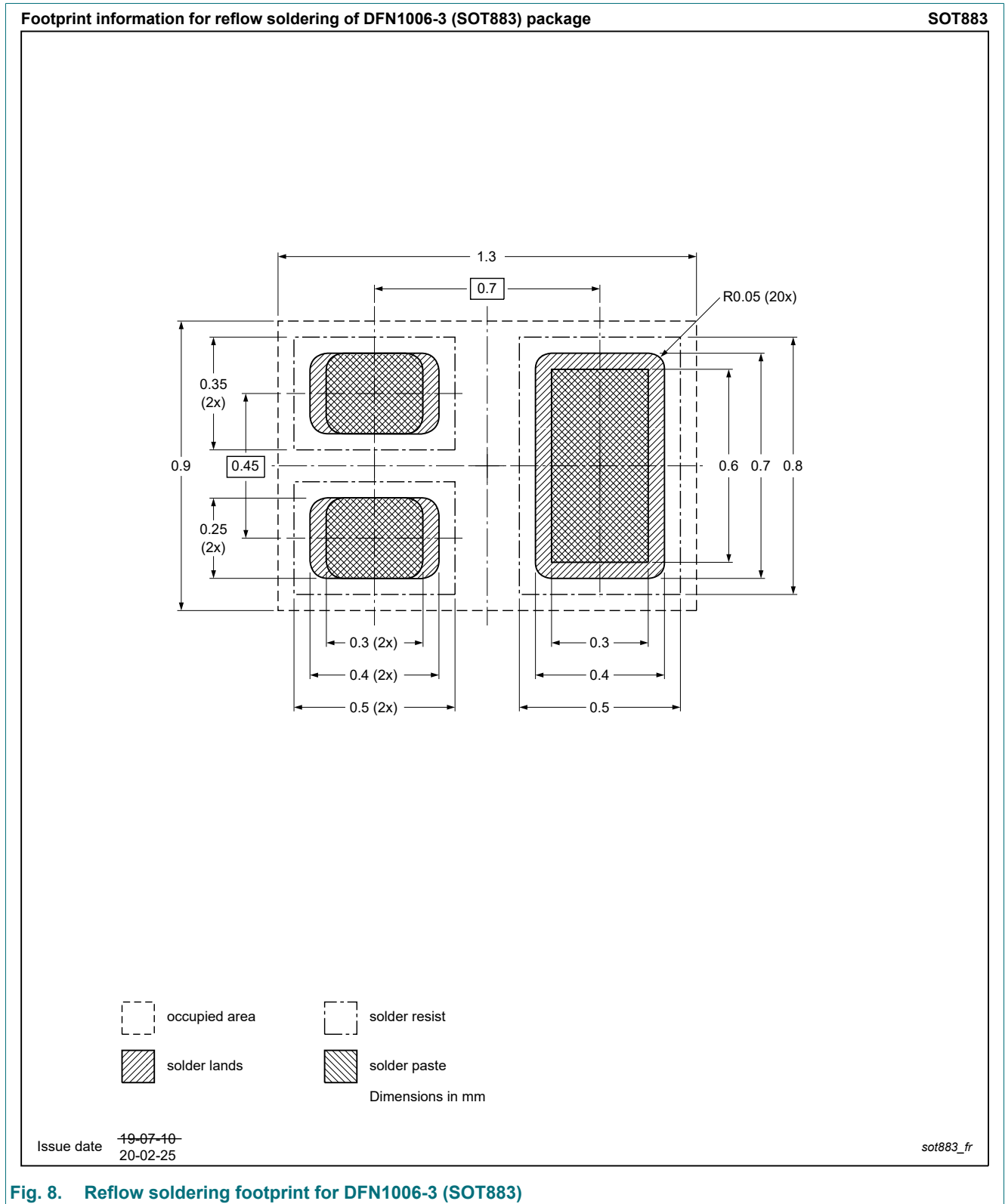


Fig. 8. Reflow soldering footprint for DFN1006-3 (SOT883)

## 14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
BAW56M v.7	20221028	Product data sheet	-	BAV756S_BAW56_SERv.6
Modification:	<ul style="list-style-type: none"> <li>Family data sheet reduced to single type data sheet.</li> <li>Packing information removed.</li> </ul>			
BAV756S_BAW56_SERv.6	20150318	Product data sheet	-	BAV756S_BAW56_SER_5
BAV756S_BAW56_SER_5	20071126	Product data sheet	-	BAV756S_2 BAW56_4 BAW56S_2 BAW56T_2 BAW56W_4
BAV756S_2	19971021	Product specification	-	BAV756S_1
BAW56_4	20030325	Product specification	-	BAW56_3
BAW56S_2	19971021	Product specification	-	BAW56S_1
BAW56T_2	19971219	Product specification	-	-
BAW56W_4	19990511	Product specification	-	BAW56W_3

## 15. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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